



## 16-Ch/Dual 8-Ch High-Performance CMOS Analog Multiplexers

### **DESCRIPTION**

The DG406 is a 16-channel single-ended analog multiplexer designed to connect one of sixteen inputs to a common output as determined by a 4-bit binary address. The DG407 selects one of eight differential inputs to a common differential output. Break-before-make switching action protects against momentary shorting of inputs.

An on channel conducts current equally well in both directions. In the off state each channel blocks voltages up to the power supply rails. An enable (EN) function allows the user to reset the multiplexer/demultiplexer to all switches off for stacking several devices. All control inputs, address ( $A_x$ ) and enable (EN) are TTL compatible over the full specified operating temperature range.

Applications for the DG406/407 include high speed data acquisition, audio signal switching and routing, ATE systems, and avionics. High performance and low power dissipation make them ideal for battery operated and remote instrumentation applications. For additional application information order Faxback document numbers 70601 and 70604.

Designed in the 44 V silicon-gate CMOS process, the absolute maximum voltage rating is extended to 44 volts, allowing operation with  $\pm~20$  V supplies. Additionally single (12 V) supply operation is allowed. An epitaxial layer prevents latchup.

For applications information please request FaxBack documents 70601 and 70604.

### **FEATURES**

- Low On-Resistance r<sub>DS(on)</sub>: 50 Ω
- Low Charge Injection Q: 15 pC
- Fast Transition Time t<sub>TRANS</sub>: 200 ns
- Low Power: 0.2 mW
- Single Supply Capability
- 44 V Supply Max Rating

## Pb-free Available



#### **BENEFITS**

- Higher Accuracy
- Reduced Glitching
- Improved Data Throughput
- Reduced Power Consumption
- · Increased Ruggedness
- Wide Supply Ranges: ± 5 V to ± 20 V

### **APPLICATIONS**

- Data Acquisition Systems
- · Audio Signal Routing
- · Medical Instrumentation
- · ATE Systems
- Battery Powered Systems
- High-Rel Systems
- · Single Supply Systems

#### FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION

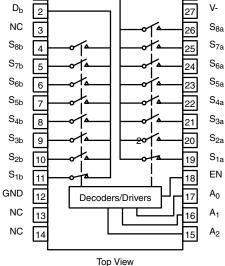
**DG406 Dual-In-Line and SOIC Wide-Body** D V+ 28 NC V-2 NC  $S_8$ 26  $S_{16}$  $S_7$ S<sub>15</sub>  $S_6$ 24 S<sub>14</sub>  $S_5$ 6 S<sub>13</sub>  $S_4$  $S_3$  $S_{12}$ 8 21 S<sub>11</sub>  $S_2$ 9 20 S<sub>10</sub>  $S_1$ 19  $S_9$ ΕN 18 11 GND  $A_0$ 17 Decoders/Drivers NC A<sub>1</sub> 16  $A_3$  $A_2$ 

Dual-In-Line and SOIC Wide-Body

V+ 1

D<sub>b</sub> 2

NC 3

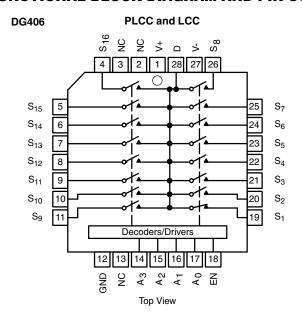


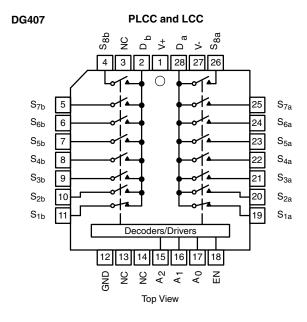
 $D_a$ 

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



### **FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION**





TRUTH TABLE - DG406									
A <sub>3</sub>	A <sub>2</sub>	A <sub>1</sub>	A <sub>0</sub>	EN	On Switch				
Х	Х	Х	Х	0	None				
0	0	0	0	1	1				
0	0	0	1	1	2				
0	0	1	0	1	3				
0	0	1	1	1	4				
0	1	0	0	1	5				
0	1	0	1	1	6				
0	1	1	0	1	7				
0	1	1	1	1	8				
1	0	0	0	1	9				
1	0	0	1	1	10				
1	0	1	0	1	11				
1	0	1	1	1	12				
1	1	0	0	1	13				
1	1	0	1	1	14				
1	1	1	0	1	15				
1	1	1	1	1	16				

TRUTH TABLE - DG407								
A <sub>2</sub>	A <sub>1</sub>	A <sub>0</sub>	EN	On Switch Pair				
Х	Х	Х	0	None				
0	0	0	1	1				
0	0	1	1	2				
0	1	0	1	3				
0	1	1	1	4				
1	0	0	1	5				
1	0	1	1	6				
1	1	0	1	7				
1	1	1	1	8				

 $\begin{array}{l} \text{Logic "0"} = V_{AL} \leq 0.8 \text{ V} \\ \text{Logic "1"} = V_{AH} \geq 2.4 \text{ V} \\ \text{X} = \text{Do not Care} \end{array}$ 

ORDERING INFORMATION - DG406							
Temp Range	Package	Part Number					
	28-Pin Plastic DIP	DG406DJ DG406DJ-E3					
- 40 to 85 °C	28-Pin PLCC	DG406DN DG406DN-T1-E3					
	28-Pin Widebody SOIC	DG406DW DG406DW-E3					

ORDERING INFORMATION - DG407								
Temp Range Package Part Number								
	28-Pin Plastic DIP	DG407DJ						
	2011111100101011	DG407DJ-E3						
- 40 to 85 °C	28-Pin PLCC	DG407DN						
40 10 05 0	20111111200	DG407DN-T1-E3						
	28-Pin Widebody SOIC	DG407DW						
	28-Fill Widebody SOIC	DG407DW-E3						



## DG406/407 Vishay Siliconix

ABSOLUTE MAXIMUM RATINGS							
Parameter		Limit	Unit				
Voltages Referenced to V-	V+	44					
voltages helefeliced to v-	GND	25	V				
Digital Inputs <sup>a</sup> , V <sub>S</sub> , V <sub>D</sub>		(V-) - 2 V to (V+) + 2 V or 20 mA, whichever occurs first					
Current (Any Terminal)		30	mA				
Peak Current, S or D (Pulsed at	1 ms, 10 % Duty Cycle Max)	100	IIIA				
Storage Temperature	(AK, AZ Suffix)	- 65 to 150	°C				
Storage Temperature	(DJ, DN Suffix)	- 65 to 125					
	28-Pin Plastic DIP <sup>b</sup>	625	mW				
	28-Pin CerDIP <sup>d</sup>	1.2	W				
Power Dissipation (Package) <sup>b</sup>	28-Pin Plastic PLCC <sup>c</sup>	450	mW				
	LCC-28 <sup>e</sup>	1.35	W				
	28-Pin Widebody SOIC	450	mW				

### Notes:

- a. Signals on SX, DX or INX exceeding V+ or V- will be clamped by internal diodes. Limit forward diode current to maximum current ratings. b. All leads soldered or welded to PC board.
- c. Derate 6 mW/°C above 75°C.
- d. Derate 12 mW/°C above 75°C.
- e. Derate 13.5 mW/°C above 75°C .

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		Test Conditions Unless Otherwise Specified V+ = 15 V, V- = - 15 V			<b>A Suffix</b> - 55 to 125 °C		D Suffix - 40 to 85 °C			
Parameter	Symbol	$V_{AL} = 0.8 \text{ V}, V_{AH} =$		Temp <sup>b</sup>	Тур <sup>с</sup>	Min <sup>d</sup>	Max <sup>d</sup>	Min <sup>d</sup>	Max <sup>d</sup>	Unit
Analog Switch	Зуппоот	TAL OIG 1, TAH		Tellip	ТУР	IVIIII	IVIAX	IVIIII	IVIAX	Oiiit
Analog Signal Range <sup>e</sup>	V <sub>ANALOG</sub>	Ī		Full		- 15	15	- 15	15	V
Drain-Source On-Resistance	r <sub>DS(on)</sub>	$V_D = \pm 10 \text{ V}, I_S = -$ Sequence Each Sw		Room Full	50		100 125		100 125	Ω
r <sub>DS(on)</sub> Matching Between Channels <sup>g</sup>	$\Delta r_{DS(on)}$	V <sub>D</sub> = ± 10 V		Room	5					%
Source Off Leakage Current	I <sub>S(off)</sub>	V <sub>EN</sub> = 0 V		Room Full	0.01	- 0.5 - 50	0.5 50	- 0.5 - 5	0.5 5	
Drain Off Leakage Current	I <sub>D(off)</sub>	$V_D = \pm 10 \text{ V}$ $V_S = \pm 10 \text{ V}$	DG406	Room Full	0.04	- 1 - 200	1 200	- 1 - 40	1 40	
J .	2(0)	3	DG407	Room Full	0.04	- 1 - 100	100	- 1 - 20	1 20	nA
Drain On Leakage Current	I <sub>D(on)</sub>	$V_S = V_D = \pm 10$ Sequence Each	DG406	Room Full	0.04	- 1 - 200	200	- 1 - 40	1 40	
	2(0)	Switch On	DG407	Room Full	0.04	- 1 - 100	1 100	- 1 - 20	1 20	
Digital Control		T			I		I	- 1	I	1
Logic High Input Voltage	V <sub>INH</sub>			Full		2.4	0.0	2.4	0.0	V
Logic Low Input Voltage	V <sub>INL</sub>	V <sub>A</sub> = 2.4 V, 15	V	Full		- 1	0.8	- 1	0.8	
Logic High Input Current  Logic Low Input Current	I <sub>AH</sub>	$V_A = 2.4 \text{ V}, 13$ $V_{EN} = 0 \text{ V}, 2.4 \text{ V}, \text{ V}$		Full Full		- I - 1	1	- 1 - 1	1	μΑ
Logic Input Capacitance	I <sub>AL</sub> C <sub>in</sub>	f = 1 MHz		Room	7	- 1	'	- 1	'	pF
Dynamic Characteristics	J <sub>III</sub>	1 - 1 101112		1100111	<u> </u>					l bi
Transition Time	t <sub>TRANS</sub>	See Figure 2	!	Room Full	200		350 450		350 450	
Break-Before-Make Interval	t <sub>OPEN</sub>	See Figure 4		Room Full	50	25 10		25 10		
Enable Turn-On Time	t <sub>ON(EN)</sub>	See Figure 3	1	Room Full	150		200 400		200 400	ns ns
Enable Turn-Off Time	t <sub>OFF(EN)</sub>			Room Full	70		150 300		150 300	
Charge Injection	Q	$V_S = 0 \text{ V, } C_L = 1 \text{ nF, I}$	-	Room	15					рC
Off Isolation <sup>h</sup>	OIRR	$V_{EN} = 0 \text{ V, R}_{L} = 0 \text{ f}$ f = 100 kHz		Room	- 69					dB
Source Off Capacitance	C <sub>S(off)</sub>	$V_{EN} = 0 \text{ V}, V_{S} = 0 \text{ V}, f$	= 1 MHz	Room	8					
Drain Off Capacitance	$C_{D(off)}$	V <sub>EN</sub> = 0 V	DG407	Room Room	130 65					pF
Drain On Capacitance	C <sub>D(on)</sub>	$V_D = 0 V$ $f = 1 MHz$ $DG400$ $DG407$		Room Room	140 70					-
Power Supplies										
Positive Supply Current	l+	V V 0 or	5 V	Room Full	13		30 75		30 75	
Negative Supply Current	I-	$V_{EN} = V_A = 0 \text{ or } 5 \text{ V}$		Room Full	- 0.01	- 1 - 10		- 1 - 10		μΑ
Positive Supply Current	l+	V <sub>EN</sub> = 2.4 V, V <sub>A</sub> =	= 0 V	Room Full	50		500 900		500 700	μ/.
Negative Supply Current	I-	v <sub>EN</sub> − 2.+ v, v <sub>A</sub> = 0 v		Room Full	- 0.01	- 20 - 20		- 20 - 20		



SPECIFICATIONS <sup>a</sup> (FOR SINGLE SUPPLY)										
		Test Conditions Unless Otherwise Specified				<b>A Suffix</b> - 55 to 125 °C		D Suffix - 40 to 85 °C		
Parameter	Symbol	V+ = 12 V, V- = 0 $V_{AL} = 0.8 V, V_{AH} = 0$		Temp <sup>b</sup>	Typ <sup>c</sup>	Min <sup>d</sup>	Max <sup>d</sup>	Min <sup>d</sup>	Max <sup>d</sup>	Unit
Analog Switch					ı		l .		ı	
Analog Signal Range <sup>e</sup>	$V_{ANALOG}$			Full		0	12	0	12	V
Drain-Source On-Resistance	r <sub>DS(on)</sub>	V <sub>D</sub> = 3 V, 10 V, I <sub>S</sub> =		Room	90		120		120	Ω
r <sub>DS(on)</sub> Matching Between Channels <sup>g</sup>	$\Delta r_{DS(on)}$	Sequence Each Swi	tch On	Room	5					%
Source Off Leakage Current	I <sub>S(off)</sub>	V <sub>EN</sub> = 0 V		Room	0.01					
Drain Off Leakage Current	ln/m	$V_D = 10 \text{ V or } 0.5 \text{ V}$	DG406	Room	0.04					
Diaiii Oii Leakage Curieiii	I <sub>D(off)</sub>	$V_S = 0.5 \text{ V or } 10 \text{ V}$	DG407	Room	0.04					nA
		$V_S = V_D = \pm 10$	DG406	Room	0.04					
Drain On Leakage Current	I <sub>D(on)</sub>	Sequence Each Switch On	DG407	Room	0.04					
Dynamic Characteristics										
Switching Time of Multiplexer	t <sub>OPEN</sub>	$V_{S1} = 8 \text{ V}, V_{S8} = 0 \text{ V}, \text{ V}$	<sub>IN</sub> = 2.4 V	Room	300		450		450	
Enable Turn-On Time	t <sub>ON(EN)</sub>	V <sub>INH</sub> = 2.4 V, V <sub>INL</sub> :	= 0 V	Room	250		600		600	ns
Enable Turn-Off Time	t <sub>OFF(EN)</sub>	V <sub>S1</sub> = 5 V		Room	150		300		300	
Charge Injection	Q	$C_L = 1 \text{ nF, } V_S = 6 \text{ V, } R_S = 0$		Room	20					рС
Power Supplies										
Positive Supply Current	l+	V <sub>EN</sub> = 0 V or 5 V, V <sub>A</sub> = 0 V or 5 V		Room Full	13		30 75		30 75	μA
Negative Supply Current	l-	VEN - O V OI O V, VA - V	0 V 01 0 V	Room Full	- 0.01	- 20 - 20		- 20 - 20		μΑ

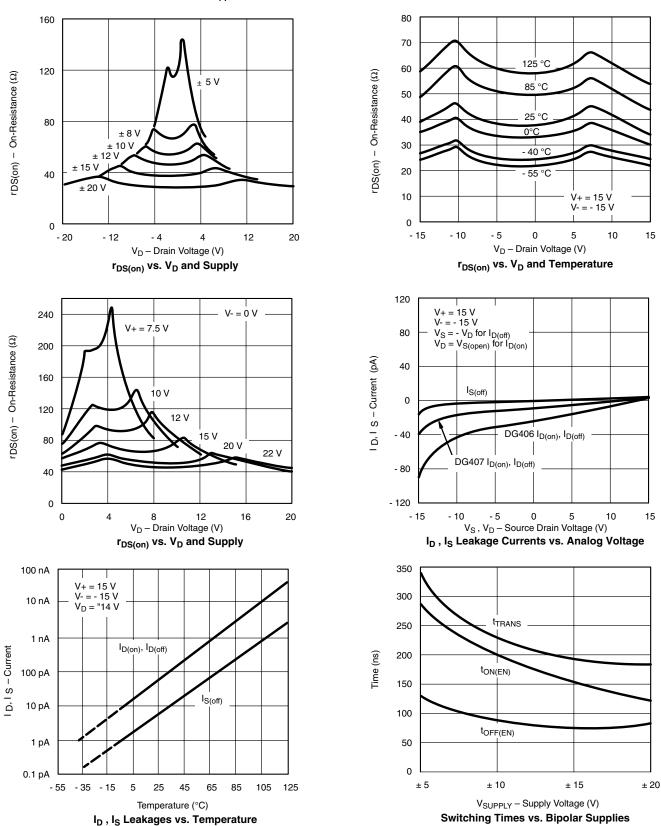
### Notes:

- a. Refer to PROCESS OPTION FLOWCHART.
- b. Room = 25  $^{\circ}$ C, Full = as determined by the operating temperature suffix.
- c. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
- d. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
- e. Guaranteed by design, not subject to production test.
- f.  $V_{IN}$  = input voltage to perform proper function.
- g.  $\Delta r_{DS(on)} = r_{DS(on)}$  MAX  $r_{DS(on)}$  MIN. h. Worst case isolation occurs on Channel 4 due to proximity to the drain pin.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

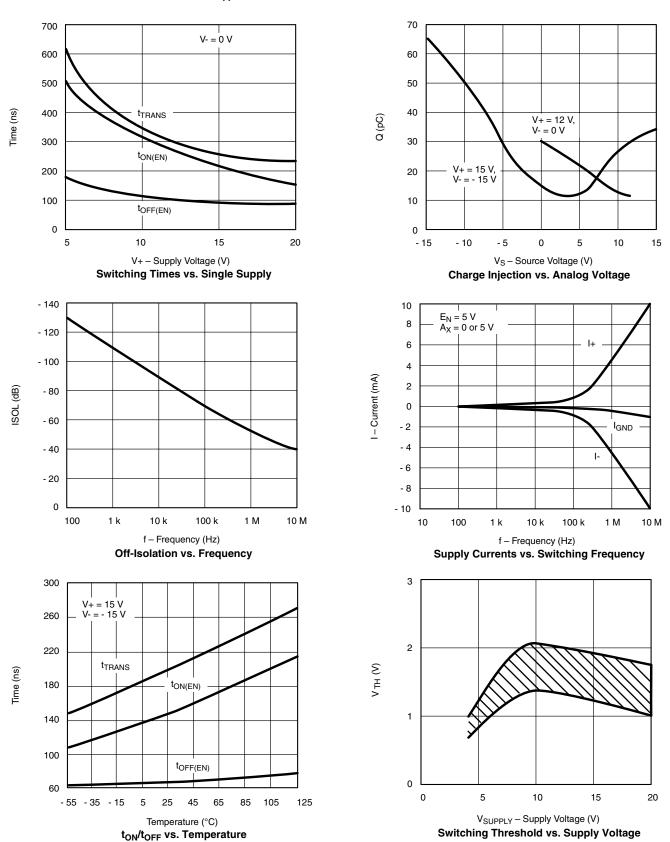
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## **TYPICAL CHARACTERISTICS** $T_A = 25$ °C, unless otherwise noted





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### **SCHEMATIC DIAGRAM (TYPICAL CHANNEL)**

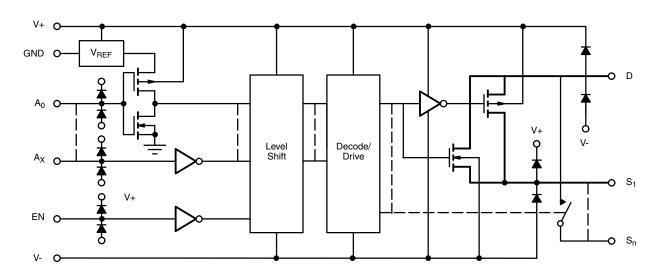


Figure 1.

### **TEST CIRCUITS**

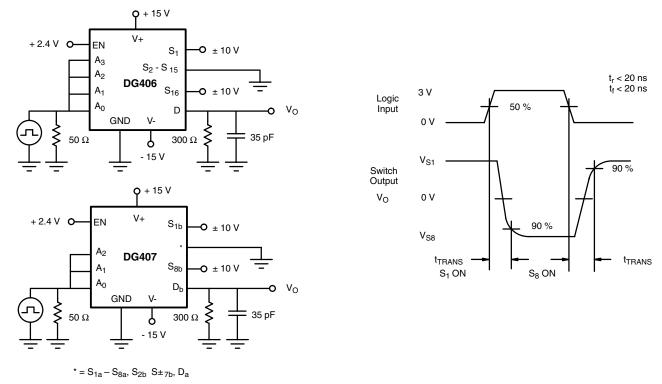


Figure 2. Transition Time



### **TEST CIRCUITS**

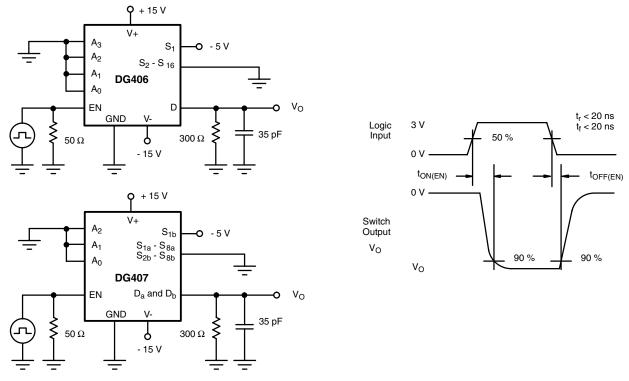


Figure 3. Enable Switching Time

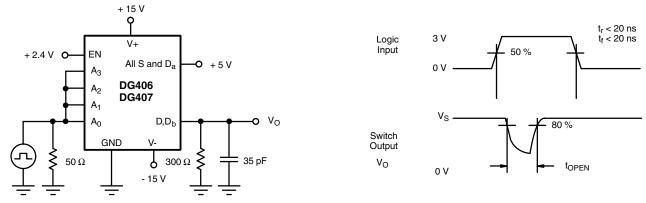


Figure 4. Break-Before-Make Interval

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### **APPLICATIONS HINTS**

Sampling speed is limited by two consecutive events: the transition time of the multiplexer, and the settling time of the sampled signal at the output.

 $t_{TRANS}$  is given on the data sheet. Settling time at the load depends on several parameters:  $r_{DS(on)}$  of the multiplexer, source impedance, multiplexer and load capacitances, charge injection of the multiplexer and accuracy desired.

The settling time for the multiplexer alone can be derived from the model shown in Figure 5. Assuming a low impedance signal source like that presented by an op amp or a buffer amplifier, the settling time of the RC network for a given accuracy is equal to  $n\tau$ :

% ACCURACY	# BITS	N
0.25	8	6
0.012	12	9
0.0017	15	11

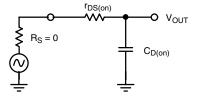


Figure 5. Simplified Model of One Multiplexer Channel

The maximum sampling frequency of the multiplexer is:

$$\begin{split} f_{_{S}} &= \frac{1}{N(t_{SETTLING} + t_{TRANS})} \\ &\quad \text{where N = number of channels to scan} \\ &\quad t_{SETTLING} = n\tau = n \ x \ r_{DS(on)} \ x \ C_{D(on)} \end{split}$$

For the DG406 then, at room temp and for 12-bit accuracy, using the maximum limits:

$$f_s = \frac{1}{16 (9 \times 100 \Omega \times 10^{-12} F) + 300 \times 10^{-12} s}$$
 (2)

10

$$f_{s} = 694 \text{ kHz} \tag{3}$$

From the sampling theorem, to properly recover the original signal, the sampling frequency should be more than twice the maximum component frequency of the original signal. This assumes perfect bandlimiting. In a real application sampling at three to four times the filter cutoff frequency is a good practice.

Therefore from equation 2 above:

$$f_{c} = \frac{1}{4} \times f_{s} = 173 \text{ kHz}$$

$$\tag{4}$$

From this we can see that the DG406 can be used to sample 16 different signals whose maximum component frequency can be as high as 173 kHz. If for example, two channels are used to double sample the same incoming signal then its cutoff frequency can be doubled.



### **APPLICATIONS HINTS**

The block diagram shown in Figure 6 illustrates a typical data acquisition front end suitable for low-level analog signals. Differential multiplexing of small signals is preferred since this method helps to reject any common mode noise. This is especially important when the sensors are located at a distance and it may eliminate the need for individual

amplifiers. A low r<sub>DS(on)</sub>, low leakage multiplexer like the DG407 helps to reduce measurement errors. The low power dissipation of the DG407 minimizes on-chip thermal gradients which can cause errors due to temperature mismatch along the parasitic thermocouple paths. Please refer to Application Note AN203 for additional information.

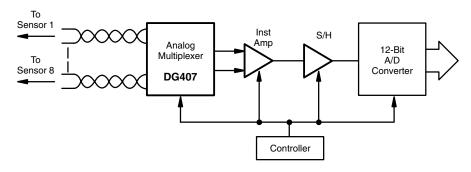


Figure 6. Measuring low-level analog signals is more accurate when using a differential multiplexing technique.

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